IceCube Upgrade Rebaseline Review April 26-28, 2022

Timo Karg WBS 1.3 Deep Ice Sensor Modules Breakout Session: Instrumentation





WBS 1.3 Scope



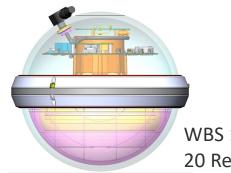
WBS 1.3.1 430 mDOMs



WBS 1.3.2 310 D-Eggs



WBS 1.3.4 900 Ice Comms Modules



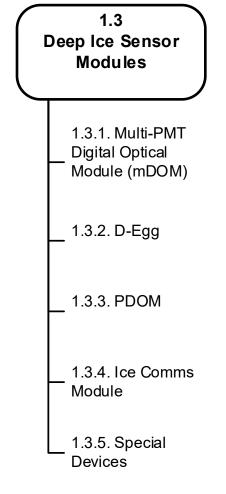
WBS 1.3.3 20 Refurbished IceCube DOMs WBS 1.3.5 Coordination of R&D Sensors





WBS 1.3: Overall Deliverables and Spares

- WBS 1.3.1 **430 mDOMs** (402 to be deployed + 28 spares + 10 DVT modules)
- WBS 1.3.2 **310 D-Eggs** (277 to be deployed + 33 spares + 10 DVT modules)
- WBS 1.3.3 **20 refurbished IceCube DOMs** (PDOMs) (14 to be deployed + 6 spares + 10 DVT modules)
- WBS 1.3.4 **900 Ice Communication Modules**, incl. firmware (803 in to-be-deployed devices + 97 spares, R&D)
- WBS 1.3.5 Coordination of Special Devices (all Special Devices are contributed in-kind)





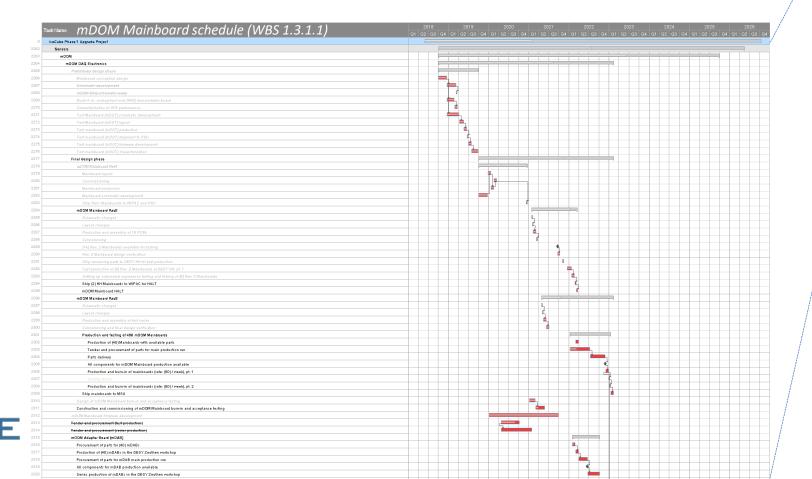


WBS 1.3: Schedule

• Full schedule, including in-kind contributions, in project-wide Smartsheet

WBS 1.3 schedule

 Percent-complete for all activities updated monthly to track progress of in-kind contributions



WBS 1.3: Shipping Schedule

- Sensors for first two strings are shipped in summer 2024
 - Will be tested on arrival at South Pole and stored DNF during the winter
- Remaining sensors are shipped on summer 2025
- Reasonable float for all sensor shipments (63 wks to 116 wks)

Cargo Item respective WBS Level	Work Package	Item Description	Contents & Comments	<u>Owner/Guardian</u> <u>institution</u>	SHIPMENT FLOAT: Time between completion and ship-by-date to USAP site	schedule]	Ship by date or actual shipment date	Expected Route: Owner - PTH or <u>CHC</u>	Recommended Transportation Option
1.3	Installation	String Sensors 87-88 (mDOMs DESY)	Optical sensors for 2 strings from Germany (mDOMs) (spares included) - Do Not Deep Freeze	DESY	440	5/19/2023	8/1/2024	DESY - CHC	ComSur
1.3	Installation	String Sensors 87-88 (mDOMs DESY)	Optical sensors for 2 strings from Germany (mDOMs) (SPARES) - Do Not Deep Freeze	DESY	440	5/19/2023	8/1/2024	DESY - CHC	ComSur
1.3	Installation	String Sensors 89-93 (mDOMs DESY)	Optical sensors for 5 strings from Germany (mDOMs) - Do Not Deep Freeze	DESY	721	8/11/2023	8/1/2025	DESY - CHC	ComSur
1.3	Installation	String Sensors 89-93 (mDOMs MSU)	Optical Sensors for 5 strings from MSU (mDOMs) - Do Not Deep Freeze	MSU	686	9/15/2023	8/1/2025	MSU - PTH	Truck
1.3	Installation	String Sensors 89-93 (mDOMs MSU)	Optical Sensors for 5 strings from MSU (mDOMs) containers (TBD) - Do Not Deep Freeze	MSU	686	9/15/2023	8/1/2025	MSU - PTH	Truck
1.3	Installation	String Sensors 87 & 88 (D-Eggs-8x)	Sensors (D-Eggs) pallets with 8 sensors at Pole overwinter - Cryo location - Do Not Deep Freeze	Chiba	736	7/27/2022	8/1/2024	ChibaU - CHC	Cargo shipment by CHU
1.3	Installation	String Sensors 87 & 88 (D-Eggs-8x)	Sensors (D-Eggs) pallets with 8 sensors at Pole overwinter (SPARES - TBD) - Cryo location - Do Not Deep Freeze	Chiba	736	7/27/2022	8/1/2024	ChibaU - CHC	Cargo shipment by CHU
1.3	Installation	String Sensors 87 & 88 (D-Eggs-12x)	Sensors (D-Eggs) pallets with 12 sensors at Pole overwinter - Cryo location - Do Not Deep Freeze	Chiba	736	7/27/2022	8/1/2024	ChibaU - CHC	Cargo shipment by CHU
1.3	Installation	String Sensors 87 & 88 (D-Eggs-12x)	Sensors (D-Eggs) patiets with 12 sensors at Pole overwinter (SPARES - TBD)- Cryo location - Do Not Deep	Chiba	736	7/27/2022	8/1/2024	ChibaU - CHC	Cargo shipment by CHU
1.3	Installation	String Sensors 89-93 (D-Eggs-8x)	Sensors (D-Eggs) pallets with 8 sensors - Do Not Deep Freeze	Chiba	812	5/12/2023	8/1/2025	ChibaU - CHC	Cargo shipment by CHU
1.3	Installation	String Sensors 89-93 (D-Eggs-12x)	Sensors (D-Eggs) pallets with 12 sensors - Do Not Deep Freeze	Chiba	812	5/12/2023	8/1/2025	ChibaU - CHC	Cargo shipment by CHU



WBS 1.3: Critical Path and Float

WBS	Task Name	Started		20)22			20	023			20	024			202	25	
	0	f×	Q1	Q2	Q3	Q4	Q1	Q2	Q3	Q4	Q1	Q2	Q3	Q4	Q1	Q2	Q3	Q4
1.3.1.1.2.3.5.2	Tender and procurement of parts for main production run	Started			- -													
1.3.1.1.2.3.5.3	Parts delivery	Not Started			+													
1.3.1.1.2.3.5.5	Production and burn-in of mainboards (rate: (60) / week), pt. 1	Not Started				_												
1.3.1.1.2.3.5.7	Production and burn-in of mainboards (rate: (60) / week), pt. 2	Not Started																
1.3.1.10.1.1.2	Integration of (54) half-mDOMs (Batch #1)	Not Started			_ _													
1.3.1.10.1.1.3	Integration of (54) half-mDOMs (Batch #2)	Not Started			, 1													
1.3.1.10.1.1.4	Integration of (54) half-mDOMs (Batch #3)	Not Started			÷													
1.3.1.10.1.1.5	Integration of (54) half-mDOMs (Batch #4)	Not Started				İ												
1.3.1.10.1.1.6	Mainboard integration and sealing Batch #1, pt. 1	Not Started				ļ.												
1.3.1.10.1.1.7	Holiday Break	Not Started					ί											
1.3.1.10.1.1.8	Mainboard integration and sealing Batch #1, pt. 2	Not Started					i.											
1.3.1.10.1.1.9	FAT Batch #1	Not Started					i i i											
1.3.1.10.1.1.10	Mounting of harness wires and packing (Batch #1)	Not Started																
1.3.1.10.1.1.11	Mainboard integration and sealing Batch #2	Not Started					İ.											
1.3.1.10.1.1.12	FAT Batch #2	Not Started						4										
1.3.1.10.1.1.13	Mounting of harness wires and packing (Batch #2)	Not Started						i i										
1.3.1.10.1.1.14	Mainboard integration and sealing Batch #3	Not Started					Í.											
1.3.1.10.1.1.15	FAT Batch #3	Not Started						• _										
1.3.1.10.1.1.16	Mounting of harness wires and packing (Batch #3)	Not Started						t										
1.3.1.10.1.1.17	Mainboard integration and sealing Batch #4	Not Started					i.											
1.3.1.10.1.1.18	FAT Batch #4	Not Started						1										
1.3.1.10.1.1.19	Mounting of harness wires and packing (Batch #4)	Not Started						Ì		~63	wks	5						
1.3.1.10.2	Ship 116 + 12 spare mDOMs for Strings 87-88 from DESY to CHC	Not Started						-					→					

- Critical path is procurement of mDOM Mainboard parts, mainboard production, and integration in mDOMs for first two strings
- Also large schedule uncertainty due to supply chain issues





WBS 1.3.1: mDOM Technical Status

- Integrated mDOM Final Design Review passed April 11-13, 2022
- Purchases of major components for series production have been expedited
 - PMT assemblies
 - Glass pressure vessel
 - Optical gel
 - Internal cabling
 - PMT support structure
 - Mainboard

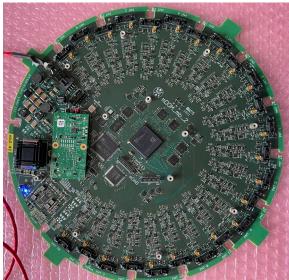
produced and delivered produced and delivered

- produced and delivered
- tendered and in production
- tender published, deadline for submission is May 6
- various electronics parts backordered
- Severe supply chain issues, esp. for main FPGA (first 200 parts expected May 2023, rest unclear)
- Same situation for similar parts and similar-sized parts from other manufacturers
- Evaluating re-design of mainboard using available parts
- Latest possible start date for redesign is January 2023



Design Verification mDOMs in Dark Freezer Lab for testing







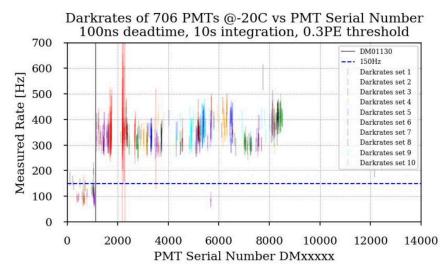
WBS 1.3.1: mDOM Production and Testing Plan

- Integration and testing will be done at DESY (225 mDOMs) and MSU (205 mDOMs)
 - Facilities at DESY and MSU ready
 - Each module will be operated in the cold for three weeks during Final Acceptance Testing before shipping to Antarctica
- Pre-production of 20 mDOMs at each site in spring/summer 2022 to exercise and optimize facilities and procedures
- Supply chain delays for several parts on the mainboard, most notably the main FPGA
 - Mitigate by producing half-mDOMs and filling in Mainboards as last step once they become available



WBS 1.3.1: mDOM PMT Dark Count Rates

- It was discovered that the dark count rate of mDOM PMTs increases significantly for serial numbers > 1130 (*)
- Increase is caused by highly time-correlated noise and is only observable at low temperature
- Root cause analysis by Hamamatsu identified radioactive contamination of the PMT glass in a newly introduced melting furnace
- All screened PMTs across the full production exceed the dark rate specification of < 150 Hz at $-20^{\circ}C$



- Replacing the PMTs has prohibitively long lead time of 2 yrs before production start at the manufacturer
- Detailed studies resulted in reasonable mitigation strategies for the increased data rate and predict only minor impacts on physics performance
- It was decided to start mDOM production with the available high-dark rate-PMTs
- Remaining risks are tracked in the risk register: TECH45, TECH48, TECH49



^(*)10,700 PMTs have been produced for the mDOM

WBS 1.3.2: D-Egg Technical Status

- Final Design Review passed in Feb. 2020
- All 310 D-Eggs have been integrated
- Final Acceptance Testing (FAT) pending
 - Each module will be operated in the cold for three weeks during FAT before shipping to Antarctica
 - D-Egg FAT is a first system integration test, including communications, DAQ, and timing system
 - Progress is slowed down by COVID travel restrictions
 - We are establishing a project-wide effort to support the D-Egg team to start final acceptance testing as quickly as possible



D-Egg FAT box w/ camera test pattern







Chiba Dark Freezer Lab



WBS 1.3.3: PDOM Technical Status

- PDOMs are Gen1 IceCube DOMs refurbished with modern electronics
 - Improve cross calibration between IceCube and the Upgrade
- Synergies used with D-Egg development
 - PDOM and D-Egg Mainboards use the same schematics
 - Expedited D-Egg development
- PDOM prototype mainboards built and comissioned
- Gen1 facilities will be used for IceCube DOM refurbishment

PDOM prototype mainboard in remote test system







WBS 1.3.4: Ice Comms Module (ICM) Technical Status

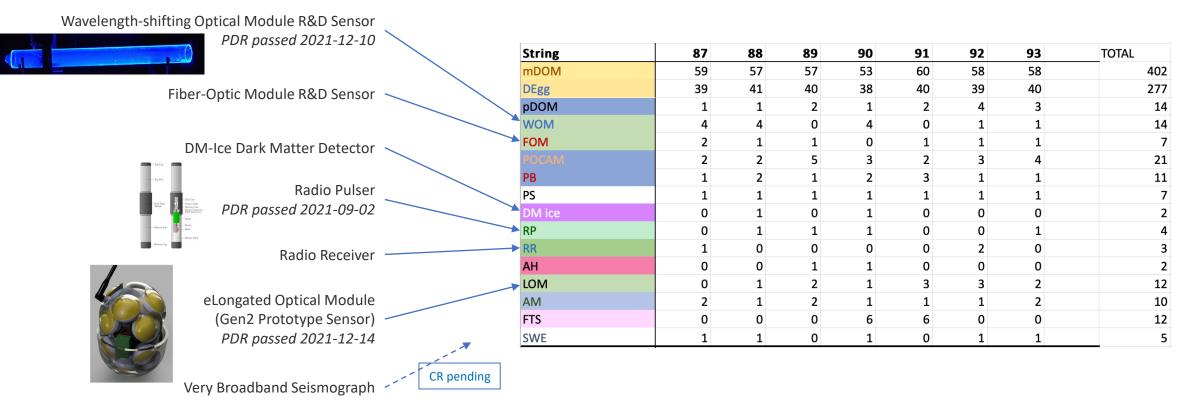
- ICM is the common interface in all Upgrade devices: DOMs, special devices, stand-alone calibration devices
- All ICMs have been produced and delivered for D-Egg integration and development and production of all devices
- ICM "Golden Image" firmware cannot be changed after installation
 - must enable communication and uploading of new firmware at all times
 - significant design, implementation, and testing effort on-award (WIPAC)







WBS 1.3.5: Special Devices Overview



- All instrumentation provided in-kind by collaborators
- Reviews
 - 2022 Preliminary Design Reviews for individual devices
 - 2023 Final Design Reviews for individual devices
 - 2024 Deployment Readiness Reviews for individual devices





Backup Material

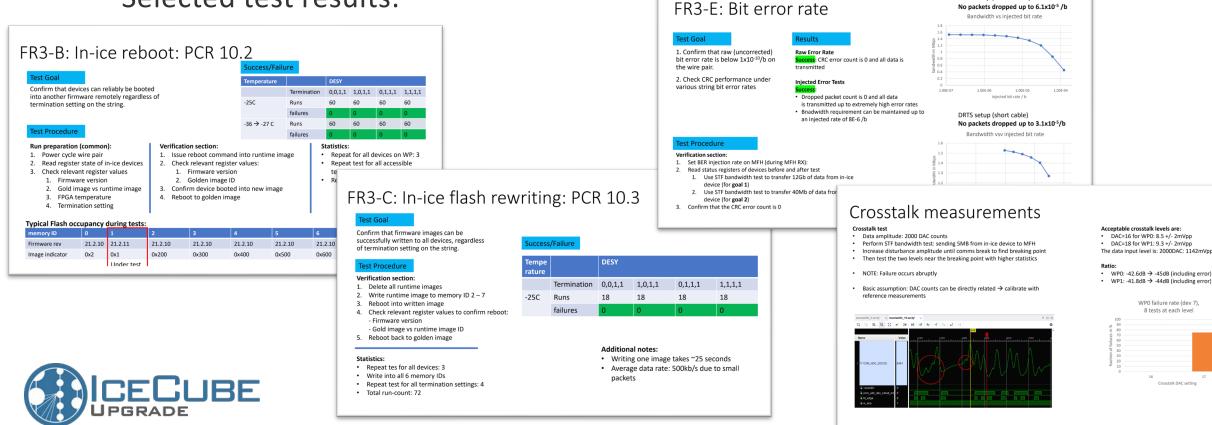




WBS 1.3.4: ICM "Golden Image" Design Verification & Review

DESY setup (2.8km cable)

- Golden Image Design Review (March 2021) passed
- Communication test setup with 2.8 km of Hexatronic triplet connected to 4 D-Egg Mainboards in a freezer
- Selected test results:



WBS 1.3: On-Award Cost

	PY1-PY4	РҮ5-РҮ8	Total
Baseline	\$1,174,963	\$155,778	\$1,330,741
Current/Actual	\$71,262 (PY4 est.)	\$218,668	\$289,930

- Major non-COVID contributions to cost difference
 - (\$756,956) cost-neutral transfer of firmware work packages from WBS 1.3 to 1.6 (Change Request #27)
 - (\$236,960) cost reduction due to reducing the number of PDOMs from 120 to 20 (Change Request #1)
- Major COVID-affected elements
 - Development and production have been delayed due to COVID





WBS 1.3: Off-Award Cost

- Cost and cost risk are tracked by in-kind partners
 → only rough estimates available here
- Majority of WBS 1.3 are in-kind contributions
 - mDOM ~\$5.6M from German collaborators, not including production facilities at DESY and MSU and labor for development, integration, and testing
 - D-Egg ~\$2.7M from Japanese collaborators, not including production facilities and labor for development and testing
 - ICM \$130k from DESY, not including labor development, production, and testing
 - Special Devices contributed in-kind from various collaborators





WBS 1.3: Risks

				_												Current Risk	_			Majq
-	~	~	Risk Identification and Tracking ~	l · · ·	× Revision History	~	~	→ Prob	ability and In		gated Ris 🗠	/aluatior ~ Exposure	~	~	~	Response ~	~	×	· · · · · · · · · · · · · · · · · · ·	Risk Flag
	Risk ID	Associated WBS	Risk Description	Risk Title	Risk Origin Date	Last	Risk Retirement Date	Risk Probability	Impact on schedule	Impact on cost	Impact on technical performance	Schedule Risk Score	Cost Risk Score	Technical Performance Risk Score	Risk Owner	Risk Occurrence Timeframe	Risk Handling Approach / Response	Risk Trigger	Risk Mitigation Plan and Actions	
	TECH31	1.3	If one of the planned sensor types does not pass FDR as scheduled the project schedule could be severely disrupted	OM FDR	8/13/2018			Low	High	Moderate	Low	Moderate	Moderate	Low	OM Lead	Until FDR, April 2022	Mitigate	FDR fails	Design and plan the production capacity of all production facilities with sufficient flexibility to be able to fall back to a different OM type	,
	TECH32	1.3.1	If bubbles remain in the mDOM Optical Gel, the optical sensitivity of the mDOM might worse than expected	mDOM Bubbles		1/27/2022		Moderate	Low	Low	Moderate	Moderate	Moderate	Moderate	mDOM Lead	Until FDR, April 2022	Mitigate	Design does not meet requirements	Optimize surface of support structure (use MJF, chemically smoothing, remove sharp edges) Implement bubbles in simulations and investigate impact on physics Gel-pad mDOM: Will delay the start of series production by several months	
	EXT9	1.3.1	If electronics parts for the mDOM Mainboard cannot be procured in time, the mDOM production and testing will be delayed	mDOM Electronics Supply Chain		1/27/2022		High	Moderate	Low	Low	High	Moderate	Moderate	OM Lead	Until procurement	Mitigate	External	Continuously monitor market throughout collaboration and centrally collect information of availability of critical components Place orders / publish calls for tender as early as possible Develop plans for series integration of half-mDOMs, add in mainboards as late as possible	
	EXT10	1.3.1	If suppliers don't have sufficient capacity to 3D-print mDOM PMT Support Structures, the mDOM production and testing will be delayed	mDOM Support Structure Supply Chain		1/27/2022		Moderate	Moderate	Low	Low	Moderate	Moderate	Moderate	OM Lead	Until procurement	Mitigate	External	Foresee production of PMT Support Structures in several batches that can be tendered to different manfufacturers	:
	TECH33	1.3.1	If mDOM series production does not reach the projected rate of 9 mDOMs / site / week, the shipping date for the mDOMs for Strings 87+88 will be missed	mDOM Production Yield		1/27/2022		Low	Moderate	Low	Low	Moderate	Low	Low	mDOM Lead	Until OM shipping	Mitigate	Technical problems	Produce mDOM test batches at DESY and MSU as early as possible to excercise integration and FAT procedures see also risk ORG5	
	EXT11	1.3	If integrated sensors have to be stored for too long before deployment, the vacuum seal might leak and re-sealing might become necessary	Sensor Long-Term Storage		1/27/2022		Low	High	Low	Low	Moderate	Low	Low	OM Lead	Until deployment	Mitigate		Regularly monitor the inside pressure of a sample of stored sensors Store sensors such that they are accessible for monitoring (not McM?)	
	TECH34	1.3.2	If during D-Egg FAT a high failure rate or design flaw is found, reworking D-Eggs will lead to significant cost and schedule slippage	D-Egg FAT Yield		1/27/2022		Low	Low	Low	Moderate	Low	Low	Moderate	D-Egg Lead	Until FAT	Mitigate		Commence D-Egg FAT as early as possible Work closely with D-Egg team on executing and interpreting FAT	
	EXT12	1.3.5	If one of the Special Devices is not delivered, the string design must be updated and verified	Special Device Cancellation	1/15/2022	1/27/2022		Very High	Low	Low	Very low	Moderate	Moderate	Moderate	OM Lead, Deployment Lead	Until deployment readiness review	Mitigate		Start early developing contingency plans how to replace or bypass missing Special Devices during deployment	
	TECH35	1.3.3	Because PDOM pressure vessels are re-furbished from Gen1, handling and resealing with new PCA may introduce subtle flaws that could cause PV flooding after deployment.	PDOM PV leak	1/15/2022	1/27/2022		Low	Moderate	Moderate	Low	Moderate	Moderate	Low	PDOM Lead	Until after freeze-in	Mitigate	No comms with deployed PDOM	Inspection of sealing surfaces, comparison of Gen1 and Gen2 PCA sealing surfaces, High Pressure testing.	
$\left \right $	EXT18	1.3.1	If mDOM planned main board electronics parts remain unavailable, a few mainboard redesign will be required: this includes hardware design effort (off of the NSF budget) and software & firmware effort (on NSF budget).	mDOM redesign	4/6/2022	4/6/2022		High	Moderate	High	Low	High	High	Moderate	mDOM lead	Calendar 2022	Mitigate	Parts delivery delays/unavailable parts	Begin planning and design work ahead of risk trigger on the new mainboard design	
	TECH36	1.3	Recause NPX is very dry, sensor electronics could be damaged by ESD during NPX testing or deployment	xDOM Electronics ESD Damage	1/15/2022	1/27/2022		Low	Low	Moderate	Low	Low	Moderate	Low	OM Lead, Deployment Lead	Until deployment	Mitigate	Modules failures, procedure errors during deployment	Employ appropriate internal ESD protection circuitry in the xDOM and ICM. Ensure that ESD mitigation is used on floors, people, and equipment at NYE. Ensure charge neutrilization is employed by procedure and equipment during NPX testing. Ensure that charge neutralization is present between electrical cables, TOS and xDOMs as they are between electrical cables, TOS and xDOMs as	



Major risks that have been discussed in plenary session



WBS 1.3: L2 Milestones

• mDOM

• April 2022	mDOM Final Design Review	Q1	20 2 Q2	22 Q3	Q4	Q1	2023 Q2 (23 G	24 Q1	Q2	2 024 Q3	Q4	Q1	2025 Q2 (
• Aug. 2022	mDOM Production Readiness Review (DESY site; after integration and testing of first 20 modules at DES	mDOM Final Design Review 78 + 18 spares D-Eggs for Strings 87-88 ready to ship to CHC mDOM Production Readiness Review (in Germany)												
• Oct. 2022	mDOM Production Readiness Review (MSU site; after integration and testing of first 20 modules at MSU	PDOM Final Design Review MDOM Production Readiness Review (in US at MSU)												
• Nov. 2022	All components for mDOM Mainboard full production available	2 + 2 spare PDOMs for Strings 87-88 ready to ship to Pt. Hueneme 12 + 4 spare PDOMs for Strings 89-93 ready to ship to Pt. Hueneme 17 + 11 spare D-Eggs for Strings 89-93 ready to ship to CHC												
• May 2023	128 mDOMs for Strings 87-88 ready to ship from DESY to CHC		128 mDOMs for Strings 87-88 ready to ship to CHC 4 96 mDOMs for Strings 89-93 ready to ship to CHC											
• Aug. 2023	96 mDOMs for Strings 89-93 ready to ship from DESY to CHC							·	mDOMs fo					ueneme

- Sept. 2023 200 mDOMs for Strings 89-93 ready to ship from MSU to Pt. Hueneme
- D-Egg
 - July 2022 78 + 18 spares D-Eggs for Strings 87-88 ready to ship from Chiba to CHC
 - May 2023 197 + 11 spare D-Eggs for Strings 89-93 ready to ship from Chiba to CHC
- PDOM
 - Sept. 2022 PDOM Final Design Review
 - Jan. 2023 14 + 6 spare PDOMs ready to ship from PSL to Pt. Hueneme



